<specification></specification>
SPEC.No. ASDIQ-SPE-141(00) Date: Aug. 16, 2022
To :
CUSTOMER'S PRODUCT NAME
ASDI PRODUCT NAME: AMPI5020N-SERIES
RECEIPT CONFIRMATION
UNCONDITIONAL CONSENT
APPROVED CHECKED
ASDI SIGNATURE
APPROVED CHECKED PREPARED   Xianglong Li Liang Wang Jiayin Cai

Г



Xiamen ASDI Electronics Co.,Ltd.

1

REV.	DATE	DESCRIPTION	APPROVED	CHECKED	PREPARED
00	Aug.16, 2022	New release	Xianglong Li	Liang Wang	Jiayin Cai

# **CAUTION WHEN HANDLING**

Before use the products, please read this specification.

## **CAUTION FOR SAFETY USING**

When use the products, be careful to mentioned below for safety using.

	CAUTION	
*The product should be used with	in 12 monthes.	
Focus on the storage conditions.		
Solderability may become weak if	it exceeds the period.	
*Do not use and store the product	•	
(Salt,Acid,Alkaline).	C C	
The products must be preheated	before soldering.	
	ng self-generated heat must be w	/ithin '- 25 ~ +125℃.
	keep the mentioned conditions in	
*In case of insert P.C. Board on cl	•	•
*Be careful to arrange of non-mag		·
The error may be caused by magi		
*In case handle the products, plea		ic discharge on human
body.		-
The product keeps away from ma	gnet or magnetized things.	
*Do not use the product beyond th		ecification.
*About an application		
The products listed on this specific	cation sheet are intended for use i	in general electronic
equipment		-
(AV equipment, telecommunicatio	ns equipment, home appliances, a	amusement equipment,
computer equipment, personal eq	uipment, office equipment, measu	irement equipment,
ndustrial robots) under a normal of	operation and use condition.	
*The products are not designed o	r warranted to meet the requireme	ents of the applications
listed below, whose performance	and/or quality require a more strin	gent level of safety or
	ction or trouble could cause serio	
	stand that we are not responsible f	
	ucts in any of the applications belo	-
exceeding the range or conditions	-	
1)Aerospace/Aviation equipment	<ol><li>6)Transportation control equip</li></ol>	
2)Military equipment	7)Power-generation control ec	
<ol><li>Seabed equipment</li></ol>	which directly endanger hu	
4)Safety equipment	8)Atomic energy-related equip	
5)Medical equipment	<ol><li>9)Other applications that are r</li></ol>	
	considered general-purpose	
If you intend to use the products in	n the following applications, please	e contact our sales
office.		
	electric trains, ships, etc.), Public ir	
• •	atus / burning equipment, Disaste	r prevention/crime
prevention equipment		
	al-purpose applications, you are ki	
÷ ·	tion circuit/equipment or providing	backup circuits, etc., to
ensure higher safety.		
	DWON	
en ASDI Electronics Co.,Ltd.	DWG.No.	ISSUE

ASDIQ-SPE-141(00)

CUSTOMER	ASDI PART No.	CUSTOMER'S DWG NO.
	AMPI5020N-SERIES	

### 1.INDEX

Listed item	Attachment&Tables	Page
1.Features	Please see (1)	3/8
2.Dimensions	Please see (2)	3/8
3.Part Numbering	Please see (3)	3/8
4.Electrical Specifications	Please see (4)	3/8
5.Material List	Please see (5)	5/8
6.Reliability Tests	Please see (6)	5/8
7.Soldering	Please see (7)	7/8
8.Packaging Information	Please see (8)	7/8
9.Note	Please see (9)	8/8

### 2.Manufacturing Location

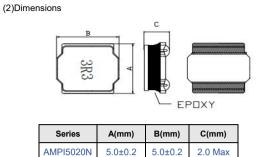
China

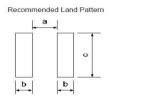
DWG.No.	ASDIQ-SPE-141(00)
Diff Children	

#### (1)Features

1.This specification applies Low Profile Power Inductors. 2.100% Lead(Pb) & Halogen-Free and RoHS compliant.







а Тур	b Typ	с Тур
2.3	1.4	4.2

#### (3)Part Numbering

AMPI	5020	Ν	 1R0	Ν
А	В	С	D	E

A: Series

B: Dimension

C: Control S/N D: Inductance

E: Inductance Tolerance M=±20%; N=±30%

1R0=1.0µH

#### (4)Electrical Specifications

Table 1

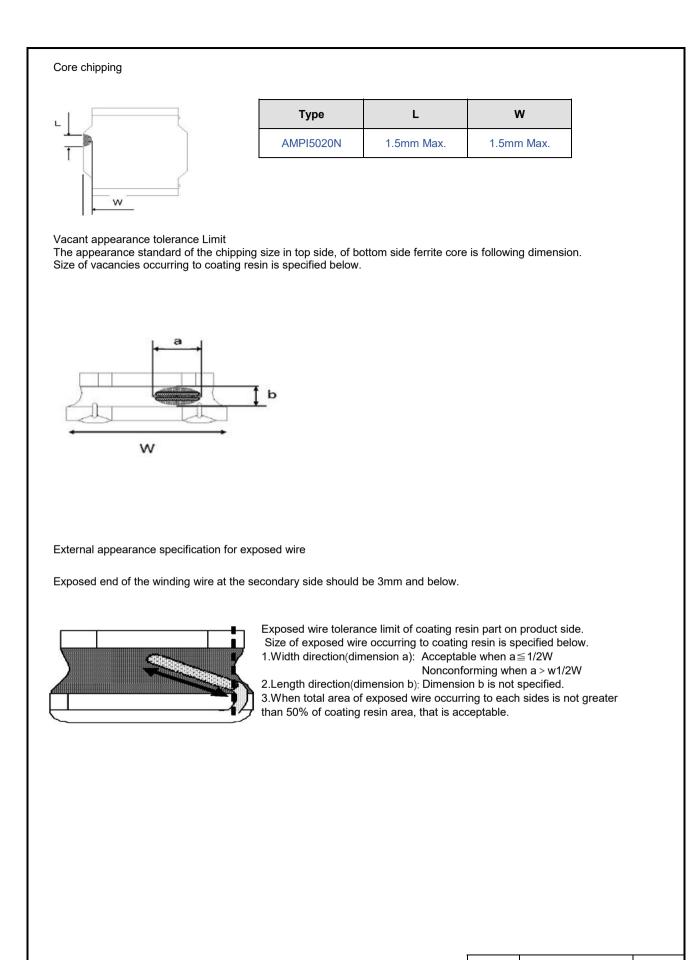
ASDI Part Number	Inductance (µH)	Tolerance (%)	Test Frequency	DCR (Ω) ±30%	I sat (A)	I rms (A)
AMPI5020N-R22N	0.22	±30%	100kHz/0.25V	0.018	5.80	5.00
AMPI5020N-R47N	0.47	±30%	100kHz/0.25V	0.020	2.80	4.90
AMPI5020N-1R0N	1.00	±30%	100kHz/0.25V	0.030	2.60	2.35
AMPI5020N-1R5N	1.50	±30%	100kHz/0.25V	0.030	2.60	2.30
AMPI5020N-2R2N/M	2.20	±30%/±20%	100kHz/0.25V	0.040	2.55	2.20
AMPI5020N-3R3N/M	3.30	±30%/±20%	100kHz/0.25V	0.050	2.50	2.20
AMPI5020N-4R7M	4.70	±20%	100kHz/0.25V	0.070	2.35	2.00
AMPI5020N-6R8M	6.80	±20%	100kHz/0.25V	0.095	2.00	1.90
AMPI5020N-100M	10.00	±20%	100kHz/0.25V	0.120	1.50	1.35
AMPI5020N-150M	15.00	±20%	100kHz/0.25V	0.155	1.20	1.10
AMPI5020N-220M	22.00	±20%	100kHz/0.25V	0.260	1.15	1.05
AMPI5020N-330M	33.00	±20%	100kHz/0.25V	0.390	0.92	0.90
AMPI5020N-470M	47.00	±20%	100kHz/0.25V	0.530	0.77	0.77
AMPI5020N-101M	100.00	±20%	100kHz/0.25V	1.100	0.53	0.53

#### Notes

Isat: Based on inductance change  $(\triangle L/L0: \leq -30\%)$  @ ambient temp. 25°C Irms: Based on temperature rise  $(\triangle T: 40°C$  typ.)

DWG.No. ASDIQ-SPE-141(00) PAGE 3/8

Xiamen ASDI Electronics Co.,Ltd.



Xiamen ASDI Electronics Co.,Ltd.

DWG.No.

#### (5)Material List

	Ð	2		3
4		1	$\checkmark$	
),	/ 4		4 (	
W	5		ų,	2
				4

	No.	Items	Materials
	1	Core	Ni-Zn ferrite
	2	Wire	Copper Wire
	3	Coating	Ероху
)	4	Solder	Lead free

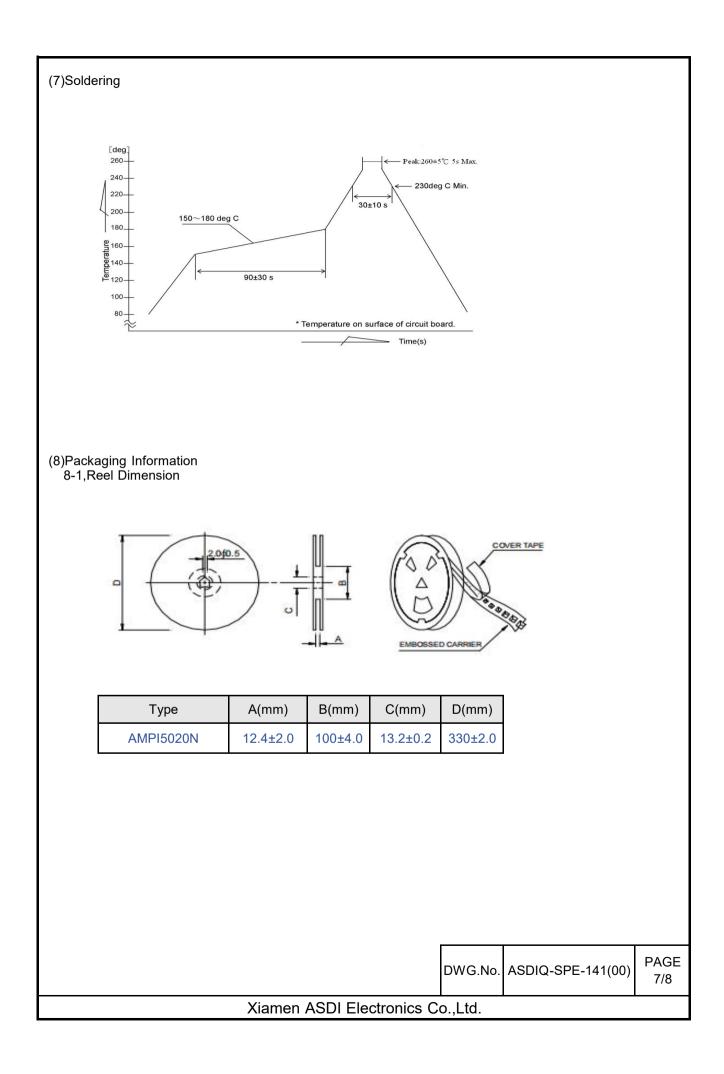
(6)Reliability Tests

Operating temperature Storage Femperature Rated current inductance (L) C Resistance	ature     -25 ~ +125 °C.       ige     -40 ~ +85 °C.       rature     - 5 to 40 °C for the product with taping.	Including self-generated heat
Femperature Rated current Inductance (L) C Resistance	ature - 5 to 40 °C for the product with taping.	
nductance (L) C Resistance	urrent	
C Resistance		
	ce (L) Within the specified tolerance	LCR Meter: HP 4285A or equivalent, 100kHz, 1V
Гemperature	stance	DC Ohmmeter: HIOKI3227 or equivalent
haracteristics		Measurement of inductance shall be taken at temperature rang within–25°C to +85°C. With reference to inductance value at+20°C,change rate shall be calculated. Measurement of inductance shall be taken at temperature rang within–40°C to +125°C. With reference to inductance value at+20°C,change rate shall be calculated.
Resistance to xure substrate		The test samples shall be soldered to the testing board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2mm.
Adhesion of Terminal electrode	inal Shall not come off PC board.	The test samples shall be soldered to the testing board and by the reflow. 10 N, 5 s Applied force: 10 N to X and Y directions. Duration: 5s Solder cream thickness: 0.15
Resistance to Vibration	0	The test samples shall be soldered to the test board by the reflow. Then it shall be submitted to below test conditions. Frequency: 10-55Hz Total Amplitude: 1.5mm (May not exceed acceleration 196m/S2) Sweeping Method:10Hz to 55Hz to 10Hz for 1min. Time: 2 hours each in X,Y, and Z Direction. Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.
		Frequency: 10-55Hz Total Amplitude: 1.5mm (May not exceed acceler 196m/S2) Sweeping Method:10Hz to 55Hz to 10Hz for 1min Time: 2 hours each in X,Y, and Z Direction. Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the
		DWG.No. ASDIQ-SPE-141(00)

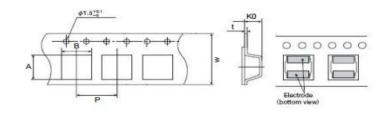
No. Test item		Performance	Test details		
10	Solderability	At least 90% of surface of terminal electrode is covered by new solder.	The test samples shall be dipped in flux, and ther immersed in molten solder as shown in below. Flux: methanol solution containing rosin 25% Solder temperature: 245±5°C Time: 5±1.0 sec. Immersion depth: All sides of mounting terminal s be immersed.		
11	Resistance to soldering	Inductance change: Within±10% No abnormality observed in appearance.	The test sample shall be exposed to reflow oven at 230±5℃ for 40 seconds, with peak temperature at 260±5℃ for 5 seconds,2 times. Test board thickness: 1.0mm Test board material: glass epoxy-resin		
12	Thermal shock		The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown below in sequence. The temperature cycles shall be repeated 100 cycles $\frac{Phase Temperature(C) Time(min.)}{1 - 40\pm33} = 30\pm3$ $\frac{2}{3} = \frac{Room Temp}{3} = \frac{VVithin 3}{3} = \frac{30\pm3}{4} = 1000000000000000000000000000000000000$		
13	Damp heat life test	Inductance change: Within±10% No abnormality observed in appearance.	Test Method and Remarks The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic over set at specified temperature and humidity as shown in below. Temperature: 60±2°C Humidity: 90~95%RH Time: 500+24/-0 hrs The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic over set at specified temperature and humidity and applied the rated current continuously as shown in below. Temperature: 60±2°C Humidity: 90~95%RH Applied current: Rated current Time: 500+24/-0 hrs		
14	Loading under damp heat life test				
15	Low temperature life test		The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below. Temperature:-40±2°C Time:500+24/-0 hrs		
16	Loading at high temperature life test		The test samples shall be soldered to the test board by the reflow. Temperature: 85±2°C. Applied current: Rated current Time: 500+24/-0 hrs.		

DWG.No. ASDIQ-SPE-141(00)
---------------------------

PAGE 6/8



#### 8-2, Tape Dimension



Series	Ao(mm	Bo(mm)	Ko(mm)	P(mm)	W(mm)	t(mm)
AMPI5020N	5.30±0.1	5.30±0.1	2.3±0.1	8.0±0.1	12±0.3	0.35±0.05

#### 8-3, Packaging Quantity

Туре	Chip / Reel		
AMPI5020N	2500		

#### (9)Note

·Storage Conditions

To maintain the solderability of terminal electrodes:

1. ASDI products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.

2. Temperature and humidity conditions: Temperature: 5 to 30deg.C, Humidity: 75% Max.

3. Recommended products should be used within 12 months form the time of delivery.

4. The packaging material should be kept where no chlorine or sulfur exists in the air.

·Transportation

1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.

2. The use of tweezers or vacuum pick up is strongly recommended for individual components.

3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

	DWG.No.	ASDIQ-SPE-141(00)	PAGE 8/8
Xiamen ASDI Electronics Co.	,Ltd.		